

GOLETA SANITARY DISTRICT

One William Moffett Place Goleta, CA 93117 Phone: (805) 967-4519

Fax: (805) 964-3583 www.goletasanitary.org

Industrial Wastewater Discharge Permit Application

Business License No._____

SECTION A - GENERAL INFORMATION

1. Company Name_

2. Mailing Address				Telep	Telephone No				
					Zip C	ode			
3. Facility A	\ddress:_								
4. *Name of Signing Official				Ti	tle		Tele. #		
Name of Contact Official				Ti	tle		_Tele. #		
Contact C	official Em	ail Address:			W	ebsite:			
6. Property 0	Owner				Tele	ephone No			
7. Assessors	s Parcel N	lumber (APN):							
		ees and Hours of Wor							
					P	RODUCTION			
		OFFICE		DAYSHIFT	S	WING SHIFT	N	IIGHT SHIFT	
					T	1100	110	LIDO	
	NO.	HRS.	NO.	HRS.	NO.	HRS.	NO.	HRS.	
WEEK DAYS	NO.	to	NO.	to	NO.	to	NO.	to	
SATURDAY	NO.	to to	NO.	to to	NO.	to to	NO.	to to	
	NO.	to	NO.	to	NO.	to	NO.	to	
SATURDAY SUNDAY		to to		to to to		to to to		to to to	
SATURDAY SUNDAY 9. Is product	ion seaso	to to to		to to to	ak produc	to to to		to to to	
SATURDAY SUNDAY 9. Is product 10.Is there a	ion seaso	to to to onal? d shutdown? When?		to to to	ak produc	to to to		to to to	
SATURDAY SUNDAY 9. Is product 10.Is there a SECTION E	ion seasc schedule B – NATU	to to to onal? d shutdown? When?	ON .	to to to to If yes, months of pe	ak produc	to to to to		to to to	
9. Is product 10.Is there a SECTION E 1. Provide	ion seasc schedule 3 – NATU a brief n	to to to onal? d shutdown? When? JRE OF OPERATION parrative description	ON of the m	to to to To If yes, months of pe anufacturing, produce	ak produc	to to to to		to to to	
9. Is product 10.Is there a SECTION E 1. Provide	ion seasc schedule 3 – NATU a brief n	to to to onal? d shutdown? When?	ON of the m	to to to To If yes, months of pe anufacturing, produce	ak produc	to to to to		to to to	
9. Is product 10.Is there a SECTION E 1. Provide	ion seasc schedule 3 – NATU a brief n	to to to onal? d shutdown? When? JRE OF OPERATION parrative description	ON of the m	to to to To If yes, months of pe anufacturing, produce	ak produc	to to to to		to to to	
9. Is product 10.Is there a SECTION E 1. Provide products:	ion seasc schedule 3 – NATU a brief n	to to to onal? d shutdown? When? JRE OF OPERATION parrative description	ON of the m	to to to To to anufacturing, produce	ak produc	to to to to		to to to	

^{*}Please see page 8 for federal regulations qualifying the signing official.

List ALL Chemic additional sheets						, industrial cleaners, lable during inspection	
Chemical Compoun Chemical Trade Na		mical acturer	Annual Usage		ompound or Frade Name	Chemical Manufacturer	Annual Usage
2. Summarize Each	Process at Your	Facility					
Process D	escription	Pro	oduction Rate		ent Standard & Subpart	NAICS Code	SIC Code
□ Go □ Sui	heck as many as vate Well leta Water Distr face Water	rict					
	ner (Specify): ter Bill:						
Address:						Zip:	
City			Stat	е		ZIP	
1. Provide the follow	ing information o	n wastewater			itimate).		
·	scharged (e.g., 8						
M	T V	V	TH	F \$	SAT	SUN	
b. Hours of Disc	narge (e.g., 9 am	to 5 pm):					
M	T V	V	TH	F \$	SAT	SUN	
2. a. Peak hourly f	low rate (GPD): _		b.	Maximum daily	flow rate (GP	D):	
c. Annual daily a	average (GPD): _		d.	Total daily flow	rate (GPD): _		
☐ Potable Water	Flow Meter						

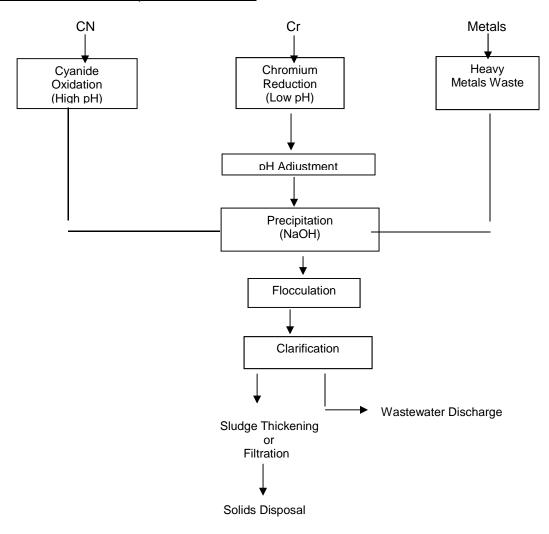
☐ Estimated by:

3. Individual process flows in gallons per day (gpd) (Attach additional sheet(s) if necessary):

Regulated Process	Average Flow (gpd)	Maximum Flow (gpd)		Type of Discharge ch, Continuous, None)	Indicate Estimated (E) or Measured (M)		
Unregulated F	Process:						
Contact Cooling Water							
Non-Contact Cooling Water							
Boiler Feed							
Process							
Sanitary – Toilets, sinks, etc.							
Air Pollution Control							
Contained in Product							
Plant and equipment washdown							
Irrigation and lawn watering							
Other							
Total							
4. If holding tank(s) is / are ι	isad dascriba maka-iin a	nd capacity:					
4. If flording talik(3) is 7 are t	asea, accombe make up a	na capacity.					
5. If batch discharge occurs	or will occur, indicate: (No	ew facilities may estima	ate)				
a. Number of batch discl	harges	per day.	d.	Flow rate	gallons/ minute		
b. Average discharge pe	er batch	(GPD)	e.	Percent of total dischar	ge		
c. Time of batch dischar	ges (days of week)	at	_				
	(days of week)	(nours of day)					
Metal Plating and Finishi	ng (If your company does no	ot perform any metal plant	ing or fir	nishing, please skip)			
a. How often are plating	solutions replenished?						
b. How often are spent o	or unusable plating solutio	ns disposed of?					
	c rinse tanks disposed to?						
	um used for plating?						
 f. At what frequency are 	clarifiers pumped or clea	ned out?					

5. Schematic Flow Diagram- Provide a schematic drawing or flow chart of each process that generates wastewater. For each activity in which wastewater is generated, draw a diagram of the flow of materials and water from start to completed product, showing all unit processes generating wastewater. Number each unit process having discharges to the public's sewer system. Use these numbers when showing this unit process in Building Layout.

EXAMPLE: Metals Precipitation Treatment



6. Provide a schematic drawing of the Building and Plumbing layout showing all wastewater generating operations which contribute to each building sewer. This building layout will enable the District and the applicant to select suitable sampling locations for determining and verifying wastewater strength.

Attach as many pages as necessary, or attach suitable plans to clearly show the location of the following facility features:

- Industrial Process Area (Show location of all wastewater generating activities listed).
- All Building Sewer Lines (Number each line leaving the building)
- Pretreatment System(s)
- Storm Drain
- Water Meter(s)
- Industrial Wastewater Sampling Location
- Floor Drains

Drawings or plans must be neat, legible and clearly labeled. If any of these features are not included, provide an explanation.

CHARACTERISTICS OF DISCHARGE

Indicate whether any of the following substances are or can be present at this facility.

Mark in **Column A** if it comes into contact with water or may be present in the wastewater.

Mark in **Column B** if it is present on site but in a location or process where no entry to the wastewater should occur.

Write "N/A" for substances that "do not apply".

I.	Metal and Inorganics		Б				-			•	_
	Antimony Barium Chromium Lead Nickel Thallium			Arseni Beryllii Coppe Mercu Seleni Zinc	um er ry			Asbesti Cadmiu Cyanid Molybd Silver	um e	<u>A</u>	<u>B</u>
II.	Phenols and Cresols Phenol (s) Phenol, 2, 4-dic Phenol, pentach Phenol, 4-nitro Phenol, 2,4-dim o- Cresol, 4,6-d	hloro nloro ethyl		<u>A</u>	<u>B</u>	Pheno Pheno Pheno	ol, 2-nitro ol, 2,4-dir	-trichchloro	<u>A</u>	<u>B</u>	
III.	Benzene, 1,2-di Benzene, 1,4-di Benzene, hexad Benzene, nitro Toluene, 2,4-dir	chloro chloro chloro	<u>ding phen</u>	ols, cres	ols and pl B C C C C C C C C C C C C C C C C C C	Benze Benze Benze Benze Toluer	ene, chlor ene, 1,3-c ene, 1,2,4 ene, ethyl	dichloro I-trichloro	<u>A</u>	<u>B</u>	
IV. 2- (PCB's and Related of PCB- 1016 PCB- 1242 Chloronaphthalene	Compoun A D D	ads B \B \B \B	PCB-	1248	<u>A</u>	<u>B</u>	PCB- 1 PCB- 1		<u>A</u>	<u>B</u>
V.	Ethers Ether, bis (2-chloroether) Ether, 2-chloroether	thyl vinyl		<u>A</u>	<u>B</u>	Ether,	4-bromo	nlorisoprop ophenyl pho phenyl pho	enyl	<u>A</u>	<u>B</u>
VI.	Nitrosamine, dir Nitrosamine, dir Nitrosamine, di- Benzidine, 3,3'- Acrylonitrile	nethyl n-propyl	gen- Con	taining C A	ompound B □ □ □ □	<u>ls</u>	Benzi	amine, dip dine uzine, 1,2-c	ĺ	<u>A</u>	<u>B</u>

Indicate whether any of the following substances are or can be present at this facility.

Mark in **Column A** if it comes into contact with water or may be present in the wastewater.

Mark in **Column B** if it is present on site but in a location or process where no entry to the wastewater should occur.

Write "N/A" for substances that "do not apply".

VII. <u>H</u>	<u> Ialogenated Aliphatics</u>					
		<u>A</u>	<u>B</u>		<u>A</u>	<u>B</u>
	Methane, bromo-			Methane, chloro-		
	Methane, dichloro			Methane, chlorodibromo		
	Methane, dichlorobromo			Methane, tribromo		
	Methane, trichloro			Methane, tetrachloro		
	Ethane, 1,1-dichloro			Ethane, 1,2-dichloro		
	Ethane, 1,1,1-trichloro			Ethane, 1,1,2-trichloro		
	Ethane, 1,1,2,2-tetrachloro			Ethane, hexachloro		
	Ethene, chlorothylene			Ethylene, 1,1-dichloro		
	Ethylene, 1, 2- trans- dichloro			Ethylene, trichloro		
	Ethene, tetrachloro			Propane, 1,2-dichloro		
	Propene, 1,3-dichloro			Butadiene, hexachloro		
	Cyclopentadiene, hexachloro					
VIII.	Phthalate Esters					
		<u>A</u>	<u>B</u>		<u>A</u>	<u>B</u>
	Phthalate, dimethyl			Phthalate, diethyl		
	Phthalate, di-n-butyl			Phthalate, di-n-octyl		
	Phthalate, bis (2-ethylhexyl)	Ш	Ш	Phthalate, butyl benzyl		Ш
IX. <u>P</u>	Polycyclic Aromatic Hydrocarbons	۸	<u>B</u>		۸	<u>B</u>
	Acenaphthene	<u>A</u>		Acenaphthylene	<u>A</u>	
	Anthracene			Benzo (a) anthracene		
	Benzo, 3,4- fluoranthene			Benzo (k) fluoranthane		
	Benzo (ghi) perylene			Benzo (a) pyrene		
	Chrysene			Fluoranthene		
	Dibenzo (a,h) anthracene			Fluorene		
	Indeno (1,2,3-cd) pyrene			Naphthalene		
	Phenanthrene			Pyrene		
	i nenanimene	Ь	ш	i yielie	ш	Ш
X. <u>Pe</u>	<u>esticides</u>	<u>A</u>	<u>B</u>		<u>A</u>	<u>B</u>
	Acrolein			Aldrin		
	BHC (Alpha)			BHC (Beta)		
	BHC (Gamma) or Lindane			BHC (Delta)		
	Chlordane			DDD		
	DDE			DDT		
	Dieldrin			Endosulfan (Alpha)		
	Endosulfan (Beta)			Endosulfan Sulfate		
	Endrin			Endrin aldehyde		
	Heptachlor			Heptachlor epoxide		
	Isophorone		Π	TCDD (or Dioxin)		
	Toxaphene			(2.5)	_ _	_

SECTION E – TREATMENT

1.	Is any form of wastewater to ☐ Yes	reatment (see list below	v) practiced a	t this facility before	e being dischar	ged to the sa	anitary sewer?
2. ye	Is any form of wastewater trans? ☐ No ☐	reatment (or changes to Yes, describe					within the next three
3.	☐ Grease or oil sep☐ Other chemical tr☐ Other, type:	Centrifuge Filtration Grit removal Screen Spill protection ent, type: caration, type:	on	Chemical precipit Flow equalization Ion exchange Sedimentation Sump Rainwater divers Other physical tre	tation [] in [] ion or storage eatment, type:	Chlorina Grease Ozonati Septic t Neutrali	ation trap on ank zation, pH correction
	Describe any changes in trewer. Please include estimated						
5.	Do you have a treatment ope	erator?	Yes		No		
(if	yes,) Name:		Title	:		Phor	ne #:
	Full time:	(specify hou	rs) Part	time:	(sr	ecify hours)	
6. 7.	☐ Yes	□ No tenance schedule for y □ No			- 10-1		
1.	Do you have chemical storage	ge containers, or ponds	s at your facil	ity?	Yes	No	
	If yes, please give a descripting am or comment on the proportion management.						
2.	Do you have floor drains in y	our manufacturing or c	chemical stora	age area(s)?	□ Yes		No
	If yes, where do they discha	rge to:					
3.	If you have chemical storage (check all that apply). an onsite dispose a storm drain	e containers, bins, or po	onds in a mar the sar to groun	nufacturing area, continuitary sewer system	ould an accide	a floor drain)
4.	·	spill prevention plan (A aclose a copy with the a ple since there are no p	application)		No	-	n entering the Sanitary
5.	Please describe below any	·					

SECTION G - NON- DISCHARGED WASTES

(4)

by the authorized representative.

1. A	re any waste liquids or sludges ge			y sewer system? remainder of section H
	Waste Generated	Quantity (per yea	ar)	Disposal Method
2. If	an outside firm removes any of the	ne above checked wastes,	state the name(s) and address(es) of all waste haulers:
	a	b.		
	Permit No. (if applicable):		ermit No. (if appli	achia).
	Реппік No. (ії арріїсаріе)	F6	ятик ічо. (ІІ арри	cable):
SECT	TION H – POLLUTION PREVE	ENTION		
1. D	escribe any pollution prevention,	source reduction, or recycl	ing measures yo	our company participates in.
		· · · · ·		
SECT	TION I – SIGNATORY REQUI	REMENT		
				the information in this application and all attachments ng the information contained in the application, I
believ		urate and complete. I am a		are significant penalties for submitting false
IIIIOIIII	ation, including the possibility of t	ine and imprisorment.		
	Name – Authorized Represent	ative	Signatur	 e
			-	
	Official Title		Date	
Certific	ation requirements: All reports must b	pe signed by an authorized inc	lividual as required	I in 40 CFR Section 403.12 and as follows:
(1)	·	,	•	is a corporation. For the purposes of this requirement a
. ,	responsible corporate officer mean	ns: (I) a president, secretary,	treasurer, or vice-	president of the corporation in charge of a principal business unctions for the corporation, or (ii) a manager of one or more
				ons or having gross annual sales or expenditures exceeding to the manager in accordance with corporate procedures.
(2)	By the general partner or proprieto	or if the industry submitting the	report is a partne	rship or sole proprietorship respectively.
(3)) and (2) above if (I) the authorization is made in writing by
	the over all operations of the facili	ty from which the industrial dis	scharge originates	fies either an individual or a position having responsibility for such as the position of plant manager, operator of a well, or all responsibility for environmental matters for the company;
	and (iii) the written authorization is			

If an authorization under paragraph (3) of this section is no longer accurate because a different individual or position has responsibility for the over all operation of the facility or overall responsibility for the environmental matter for the company, a new authorization satisfying the requirements of paragraph (3) of this section must be submitted to the Industrial Waste Control Officer to or together with any reports signed